DIMENSIONS
(OF BASIC CONFIGURATION)

POWERFUL CAD-CAM AND SOFTWARE PACKAGE
WIRING, DRILLING AND PCB CUTTING IN ONE PROCESS
PROCESSING OF ALL KIND OF CIRCUIT BOARDS WITHOUT THERMAL STRESS

HIGH RESOLUTION PCB PROTOTYPING USING DIRECT LASER ABLATION

LASER SYSTEM FOR PCB PROTOTYPING
RDX 500 PCB

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LASER SYSTEM FOR HIGH QUALITY PCB PROTOYPING

The RDX500 PCB is an all-in-one system for laser microprocessing of circuit boards. By using a femtosecond laser, any type of printed circuit board can be processed with the highest precision, low thermal input and virtually without post-processing. Thus, in addition to conventional laminated circuit boards made of polymers, ceramic circuit boards, e.g. for high-frequency technology, can also be processed. The laser processing machine allows the printed circuit board to be structured, drilled and cut out on both sides in one process. Thus, complex intermediate steps can be saved and the use of the technology is made easier. The user is supported by powerful software that guides him step-by-step from production planning to the finished PCB.

PROCESS CHAMBER

The process chamber has a vacuum clamping system for stable fixing of printed circuit boards. By using a high-precision axis system and a range of measuring and processing tools, printed circuit boards can be precisely measured and processed over large areas. An integrated suction system ensures clean ablation and removal of the ablation products.

ABLATION, DRILLING, CUTTING

The conductor tracks are produced by a precise femtosecond laser ablation process. The high-precision and layer-wise processing enables ablation of the metallic layers with no or just minimal damage to underlying layers. A high lateral resolution can be achieved due to a melt and burr free ablation process. Via-holes with adjustable diameters can be produced by laser drilling. Finally, the complete PCB is cut by a laser cutting process.

TECHNICAL DATA

<table>
<thead>
<tr>
<th>Specifications</th>
<th>Details</th>
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</thead>
<tbody>
<tr>
<td>Machine system</td>
<td>The RDX500 PCB is a fully integrated and turnkey ready laser machine for laser based circuit board prototyping and small series production. The machine consists of a laser safety class 1 machine housing with control panel, laser, vibration damped machine base with axis system, vacuum chuck and exhaust system for particle removal. The compact size of the laser machine allows an installation even in small rooms.</td>
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<tr>
<td>Work field area</td>
<td>Motorized machine axes: XY cross table, Z stage Working area: typ. 210 mm x 290 mm  Repeatability of positioning: &lt; ± 1 micron</td>
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<td>Optical Scanning System Accuracy</td>
<td>Galvanometer-Scanner with Focusing objective  Spot size: typ. 20 μm (IR), 10 μm (VIS), smaller spot sizes possible  Minimum line width: 50 μm* (IR, standard), 25 μm (VIS)  Minimum gap width: 25 μm* (IR, standard), smaller sizes possible *on laminated substrate (18 μm Cu)</td>
</tr>
<tr>
<td>Laser source</td>
<td>Femtosecond laser system (industrial-ready) for high precision and melt-free laser ablation  Wavelength: 1030nm, 515nm or 343nm</td>
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<tr>
<td>Software / CAD-CAM</td>
<td>Machine control: PhotonicElements  CAD-CAM tool: PhotonicVectors  Software assistant for PCB-Prototyping</td>
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<td>Electric cabinet</td>
<td>400 VAC, 16A, 50 Hz</td>
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<td>Measurement technology</td>
<td>Camera System CM-R2 (LED-illumination, fiducial recognition)  Tactical probe sensor for distance control</td>
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<td>Accessories</td>
<td>Vacuum chuck, Exhaust unit, Process gas system</td>
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<tr>
<td>Services</td>
<td>Application development, CAD/CAM training, USP laser training, Remote maintenance, Remote process support, Software development</td>
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KEY ELEMENTS OF RDX500

Precise laser cut  Laser drilled via-holes  Fine circuit tracks by laser ablation  POWERFUL SOFTWARE PACKAGE

Work preparation is carried out with the CAD-CAM program PhotonicVectors which allows GerberX data for wiring, the drilling process and the cutting contours to be loaded and a machining job to be generated. The job data is transferred to the PhotonicElements machine software. A software assistant guides the user from the automated measuring of the unprocessed PCB (fiducial recognition), through the configuration of the laser processing to the finished PCB.